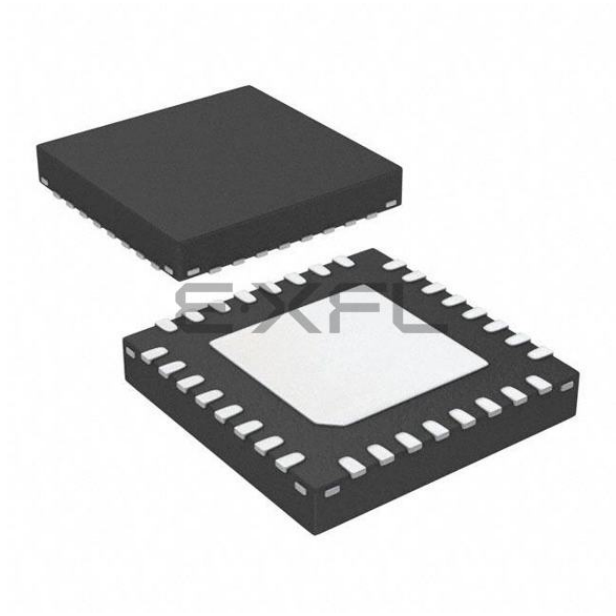

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Details	
Product Status	Active
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Core Size	32-Bit Single-Core
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Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	28
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	32-VQFN Exposed Pad
Supplier Device Package	32-HVQFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1114jhn33-303e

Table 2. Ordering options *…continued*

Type number	Series	Flash	Total SRAM	Power profiles	UART	I^2C/ Fast+	SPI	ADC channel	GPIO	Package	Temp[1]
LPC1115JBD48/303	LPC1100XL	64 kB	8 kB	yes	1	1	2	8	42	LQFP48	J
LPC1115FET48/303	LPC1100XL	64 kB	8 kB	yes	1	1	2	8	42	TFBGA48	F
LPC1115JET48/303	LPC1100XL	64 kB	8 kB	yes	1	1	2	8	42	TFBGA48	J

[1] F = −40 °C to +85 °C, J = −40 °C to +105 °C.

Table 6. LPC1100L series: LPC1112 (HVQFN24 package) *…continued*

Symbol	HVQFN pin	Start logic input	Type	Reset state [1]	Description
PIO0_5/SDA	9[4]	yes	I/O	I; IA	**PIO0_5 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SDA —** I^2C-bus, open-drain data input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/SCK0	10[3]	yes	I/O	I; PU	**PIO0_6 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.
PIO0_7/$\overline{\text{CTS}}$	11[3]	yes	I/O	I; PU	**PIO0_7 —** General purpose digital input/output pin (high-current output driver).
			I	-	**$\overline{\text{CTS}}$ —** Clear To Send input for UART.
PIO0_8/MISO0/ CT16B0_MAT0	12[3]	yes	I/O	I; PU	**PIO0_8 —** General purpose digital input/output pin.
			I/O	-	**MISO0 —** Master In Slave Out for SPI0.
			O	-	**CT16B0_MAT0 —** Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/ CT16B0_MAT1	13[3]	yes	I/O	I; PU	**PIO0_9 —** General purpose digital input/output pin.
			I/O	-	**MOSI0 —** Master Out Slave In for SPI0.
			O	-	**CT16B0_MAT1 —** Match output 1 for 16-bit timer 0.
SWCLK/PIO0_10/ SCK0/ CT16B0_MAT2	14[3]	yes	I	I; PU	**SWCLK —** Serial wire clock.
			I/O	-	**PIO0_10 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.
			O	-	**CT16B0_MAT2 —** Match output 2 for 16-bit timer 0.
R/PIO0_11/ AD0/CT32B0_MAT3	15[5]	yes	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	**PIO0_11 —** General purpose digital input/output pin.
			I	-	**AD0 —** A/D converter, input 0.
			O	-	**CT32B0_MAT3 —** Match output 3 for 32-bit timer 0.
R/PIO1_0/ AD1/CT32B1_CAP0	16[5]	yes	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	**PIO1_0 —** General purpose digital input/output pin.
			I	-	**AD1 —** A/D converter, input 1.
			I	-	**CT32B1_CAP0 —** Capture input 0 for 32-bit timer 1.
R/PIO1_1/ AD2/CT32B1_MAT0	17[5]	no	O	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	**PIO1_1 —** General purpose digital input/output pin.
			I	-	**AD2 —** A/D converter, input 2.
			O	-	**CT32B1_MAT0 —** Match output 0 for 32-bit timer 1.
R/PIO1_2/ AD3/CT32B1_MAT1	18[5]	no	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	**PIO1_2 —** General purpose digital input/output pin.
			I	-	**AD3 —** A/D converter, input 3.
			O	-	**CT32B1_MAT1 —** Match output 1 for 32-bit timer 1.

Table 7. LPC1100L series: LPC1112/14 pin description table (TSSOP28 and DIP28 packages)

Symbol	Pin TSSOP28/ DIP28	Start logic input	Type	Reset state [1]	Description
PIO0_0 to PIO0_11			I/O		**Port 0 —** Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block.
$\overline{\text{RESET}}$/PIO0_0	23 [2]	yes	I	I; PU	**$\overline{\text{RESET}}$ —** External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The $\overline{\text{RESET}}$ pin can be left unconnected or be used as a GPIO pin if an external $\overline{\text{RESET}}$ function is not needed and Deep power-down mode is not used.
			I/O	-	**PIO0_0 —** General purpose digital input/output pin with 10 ns glitch filter.
PIO0_1/CLKOUT/ CT32B0_MAT2	24 [3]	yes	I/O	I; PU	**PIO0_1 —** General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler.
			O	-	**CLKOUT —** Clockout pin.
			O	-	**CT32B0_MAT2 —** Match output 2 for 32-bit timer 0.
PIO0_2/SSEL0/ CT16B0_CAP0	25 [3]	yes	I/O	I; PU	**PIO0_2 —** General purpose digital input/output pin.
			I/O	-	**SSEL0 —** Slave Select for SPI0.
			I	-	**CT16B0_CAP0 —** Capture input 0 for 16-bit timer 0.
PIO0_3	26 [3]	yes	I/O	I; PU	**PIO0_3 —** General purpose digital input/output pin.
PIO0_4/SCL	27 [4]	yes	I/O	I; IA	**PIO0_4 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SCL —** I^2C-bus, open-drain clock input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_5/SDA	5 [4]	yes	I/O	I; IA	**PIO0_5 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SDA —** I^2C-bus, open-drain data input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/SCK0	6 [3]	yes	I/O	I; PU	**PIO0_6 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.
PIO0_7/$\overline{\text{CTS}}$	28 [3]	yes	I/O	I; PU	**PIO0_7 —** General purpose digital input/output pin (high-current output driver).
			I	-	**$\overline{\text{CTS}}$ —** Clear To Send input for UART.
PIO0_8/MISO0/ CT16B0_MAT0	1 [3]	yes	I/O	I; PU	**PIO0_8 —** General purpose digital input/output pin.
			I/O	-	**MISO0 —** Master In Slave Out for SPI0.
			O	-	**CT16B0_MAT0 —** Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/ CT16B0_MAT1	2 [3]	yes	I/O	I; PU	**PIO0_9 —** General purpose digital input/output pin.
			I/O	-	**MOSI0 —** Master Out Slave In for SPI0.
			O	-	**CT16B0_MAT1 —** Match output 1 for 16-bit timer 0.

Table 7. LPC1100L series: LPC1112/14 pin description table (TSSOP28 and DIP28 packages) *…continued*

Symbol	Pin TSSOP28/ DIP28	Start logic input	Type	Reset state [1]	Description
PIO1_5/$\overline{\text{RTS}}$/ CT32B0_CAP0	14 [3]	no	I/O	I; PU	**PIO1_5 —** General purpose digital input/output pin.
			O	-	**$\overline{\text{RTS}}$ —** Request To Send output for UART.
			I	-	**CT32B0_CAP0 —** Capture input 0 for 32-bit timer 0.
PIO1_6/RXD/ CT32B0_MAT0	15 [3]	no	I/O	I; PU	**PIO1_6 —** General purpose digital input/output pin.
			I	-	**RXD —** Receiver input for UART.
			O	-	**CT32B0_MAT0 —** Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	16 [3]	no	I/O	I; PU	**PIO1_7 —** General purpose digital input/output pin.
			O	-	**TXD —** Transmitter output for UART.
			O	-	**CT32B0_MAT1 —** Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	17 [3]	no	I/O	I; PU	**PIO1_8 —** General purpose digital input/output pin.
			I	-	**CT16B1_CAP0 —** Capture input 0 for 16-bit timer 1.
PIO1_9/ CT16B1_MAT0	18 [3]	no	I/O	I; PU	**PIO1_9 —** General purpose digital input/output pin.
			O	-	**CT16B1_MAT0 —** Match output 0 for 16-bit timer 1.
V_{DD}	21	-		-	3.3 V supply voltage to the internal regulator and the external rail.
V_{DDA}	7	-	-	-	3.3 V supply voltage to the ADC. Also used as the ADC reference voltage.
XTALIN	20 [6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	19 [6]	-	O	-	Output from the oscillator amplifier.
V_{SS}	22	-		-	Ground.
V_{SSA}	8	-	-	-	Analog ground.

[1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to full V_{DD} level); IA = inactive, no pull-up/down enabled.

[2] 5 V tolerant pad. $\overline{\text{RESET}}$ functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See Figure 52 for the reset pad configuration.

[3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see Figure 51).

[4] I^2C-bus pads compliant with the I^2C-bus specification for I^2C standard mode and I^2C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I2C lines. Open-drain configuration applies to all functions on this pin.

[5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled and the pin is not 5 V tolerant (see Figure 51).

[6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

Table 8. LPC1100 and LPC1100L series: LPC1113/14 pin description table (LQFP48 package) *…continued*

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
PIO1_6/RXD/ CT32B0_MAT0	46[3]	no	I/O	I; PU	**PIO1_6 —** General purpose digital input/output pin.
			I	-	**RXD —** Receiver input for UART.
			O	-	**CT32B0_MAT0 —** Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	47[3]	no	I/O	I; PU	**PIO1_7 —** General purpose digital input/output pin.
			O	-	**TXD —** Transmitter output for UART.
			O	-	**CT32B0_MAT1 —** Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	9[3]	no	I/O	I; PU	**PIO1_8 —** General purpose digital input/output pin.
			I	-	**CT16B1_CAP0 —** Capture input 0 for 16-bit timer 1.
PIO1_9/ CT16B1_MAT0	17[3]	no	I/O	I; PU	**PIO1_9 —** General purpose digital input/output pin.
			O	-	**CT16B1_MAT0 —** Match output 0 for 16-bit timer 1.
PIO1_10/AD6/ CT16B1_MAT1	30[5]	no	I/O	I; PU	**PIO1_10 —** General purpose digital input/output pin.
			I	-	**AD6 —** A/D converter, input 6.
			O	-	**CT16B1_MAT1 —** Match output 1 for 16-bit timer 1.
PIO1_11/AD7	42[5]	no	I/O	I; PU	**PIO1_11 —** General purpose digital input/output pin.
			I	-	**AD7 —** A/D converter, input 7.
PIO2_0 to PIO2_11			I/O		**Port 2 —** Port 2 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 2 pins depends on the function selected through the IOCONFIG register block.
PIO2_0/$\overline{\text{DTR}}$/SSEL1	2[3]	no	I/O	I; PU	**PIO2_0 —** General purpose digital input/output pin.
			O	-	**$\overline{\text{DTR}}$ —** Data Terminal Ready output for UART.
			I/O	-	**SSEL1 —** Slave Select for SPI1.
PIO2_1/$\overline{\text{DSR}}$/SCK1	13[3]	no	I/O	I; PU	**PIO2_1 —** General purpose digital input/output pin.
			I	-	**$\overline{\text{DSR}}$ —** Data Set Ready input for UART.
			I/O	-	**SCK1 —** Serial clock for SPI1.
PIO2_2/$\overline{\text{DCD}}$/MISO1	26[3]	no	I/O	I; PU	**PIO2_2 —** General purpose digital input/output pin.
			I	-	**$\overline{\text{DCD}}$ —** Data Carrier Detect input for UART.
			I/O	-	**MISO1 —** Master In Slave Out for SPI1.
PIO2_3/$\overline{\text{RI}}$/MOSI1	38[3]	no	I/O	I; PU	**PIO2_3 —** General purpose digital input/output pin.
			I	-	**$\overline{\text{RI}}$ —** Ring Indicator input for UART.
			I/O	-	**MOSI1 —** Master Out Slave In for SPI1.
PIO2_4	19[3]	no	I/O	I; PU	**PIO2_4 —** General purpose digital input/output pin.
PIO2_5	20[3]	no	I/O	I; PU	**PIO2_5 —** General purpose digital input/output pin.
PIO2_6	1[3]	no	I/O	I; PU	**PIO2_6 —** General purpose digital input/output pin.
PIO2_7	11[3]	no	I/O	I; PU	**PIO2_7 —** General purpose digital input/output pin.
PIO2_8	12[3]	no	I/O	I; PU	**PIO2_8 —** General purpose digital input/output pin.
PIO2_9	24[3]	no	I/O	I; PU	**PIO2_9 —** General purpose digital input/output pin.
PIO2_10	25[3]	no	I/O	I; PU	**PIO2_10 —** General purpose digital input/output pin.
PIO2_11/SCK0	31[3]	no	I/O	I; PU	**PIO2_11 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.

Table 9. LPC1100 and LPC1100L series: LPC1111/12/13/14 pin description table (HVQFN33 package)

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
PIO0_0 to PIO0_11					**Port 0 —** Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block.
$\overline{\text{RESET}}$/PIO0_0	2[2]	yes	I	I;PU	**$\overline{\text{RESET}}$ —** External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The $\overline{\text{RESET}}$ pin can be left unconnected or be used as a GPIO pin if an external $\overline{\text{RESET}}$ function is not needed and Deep power-down mode is not used.
			I/O	-	**PIO0_0 —** General purpose digital input/output pin with 10 ns glitch filter.
PIO0_1/CLKOUT/ CT32B0_MAT2	3[3]	yes	I/O	I;PU	**PIO0_1 —** General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler.
			O	-	**CLKOUT —** Clock out pin.
			O	-	**CT32B0_MAT2 —** Match output 2 for 32-bit timer 0.
PIO0_2/SSEL0/ CT16B0_CAP0	8[3]	yes	I/O	I;PU	**PIO0_2 —** General purpose digital input/output pin.
			I/O	-	**SSEL0 —** Slave select for SPI0.
			I	-	**CT16B0_CAP0 —** Capture input 0 for 16-bit timer 0.
PIO0_3	9[3]	yes	I/O	I;PU	**PIO0_3 —** General purpose digital input/output pin.
PIO0_4/SCL	10[4]	yes	I/O	I;IA	**PIO0_4 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SCL —** I^2C-bus, open-drain clock input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_5/SDA	11[4]	yes	I/O	I;IA	**PIO0_5 —** General purpose digital input/output pin (open-drain).
			I/O	-	**SDA —** I^2C-bus, open-drain data input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/SCK0	15[3]	yes	I/O	I;PU	**PIO0_6 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.
PIO0_7/$\overline{\text{CTS}}$	16[3]	yes	I/O	I;PU	**PIO0_7 —** General purpose digital input/output pin (high-current output driver).
			I	-	**$\overline{\text{CTS}}$ —** Clear To Send input for UART.
PIO0_8/MISO0/ CT16B0_MAT0	17[3]	yes	I/O	I;PU	**PIO0_8 —** General purpose digital input/output pin.
			I/O	-	**MISO0 —** Master In Slave Out for SPI0.
			O	-	**CT16B0_MAT0 —** Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/ CT16B0_MAT1	18[3]	yes	I/O	I;PU	**PIO0_9 —** General purpose digital input/output pin.
			I/O	-	**MOSI0 —** Master Out Slave In for SPI0.
			O	-	**CT16B0_MAT1 —** Match output 1 for 16-bit timer 0.
SWCLK/PIO0_10/ SCK0/ CT16B0_MAT2	19[3]	yes	I	I;PU	**SWCLK —** Serial wire clock.
			I/O	-	**PIO0_10 —** General purpose digital input/output pin.
			I/O	-	**SCK0 —** Serial clock for SPI0.
			O	-	**CT16B0_MAT2 —** Match output 2 for 16-bit timer 0.

Table 9. LPC1100 and LPC1100L series: LPC1111/12/13/14 pin description table (HVQFN33 package) *…continued*

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
PIO1_7/TXD/ CT32B0_MAT1	32[3]	no	I/O	I;PU	**PIO1_7 —** General purpose digital input/output pin.
			O	-	**TXD —** Transmitter output for UART.
			O	-	**CT32B0_MAT1 —** Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	7[3]	no	I/O	I;PU	**PIO1_8 —** General purpose digital input/output pin.
			I	-	**CT16B1_CAP0 —** Capture input 0 for 16-bit timer 1.
PIO1_9/ CT16B1_MAT0	12[3]	no	I/O	I;PU	**PIO1_9 —** General purpose digital input/output pin.
			O	-	**CT16B1_MAT0 —** Match output 0 for 16-bit timer 1.
PIO1_10/AD6/ CT16B1_MAT1	20[5]	no	I/O	I;PU	**PIO1_10 —** General purpose digital input/output pin.
			I	-	**AD6 —** A/D converter, input 6.
			O	-	**CT16B1_MAT1 —** Match output 1 for 16-bit timer 1.
PIO1_11/AD7	27[5]	no	I/O	I;PU	**PIO1_11 —** General purpose digital input/output pin.
			I	-	**AD7 —** A/D converter, input 7.
PIO2_0					**Port 2 —** Port 2 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 2 pins depends on the function selected through the IOCONFIG register block. Pins PIO2_1 to PIO2_11 are not available.
PIO2_0/$\overline{\text{DTR}}$	1[3]	no	I/O	I;PU	**PIO2_0 —** General purpose digital input/output pin.
			O	-	**$\overline{\text{DTR}}$ —** Data Terminal Ready output for UART.
PIO3_0 to PIO3_5					**Port 3 —** Port 3 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 3 pins depends on the function selected through the IOCONFIG register block. Pins PIO3_0, PIO3_1, PIO3_3 and PIO3_6 to PIO3_11 are not available.
PIO3_2	28[3]	no	I/O	I;PU	**PIO3_2 —** General purpose digital input/output pin.
PIO3_4	13[3]	no	I/O	I;PU	**PIO3_4 —** General purpose digital input/output pin.
PIO3_5	14[3]	no	I/O	I;PU	**PIO3_5 —** General purpose digital input/output pin.
V_{DD}	6; 29	-	I	-	3.3 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
XTALIN	4[6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	5[6]	-	O	-	Output from the oscillator amplifier.
V_{SS}	33	-	-	-	Thermal pad. Connect to ground.

[1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to 2.6 V for LPC111x/101/201/301, pins pulled up to full V_{DD} level on LPC111x/002/102/202/302 (V_{DD} = 3.3 V)); IA = inactive, no pull-up/down enabled.

[2] 5 V tolerant pad. $\overline{\text{RESET}}$ functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See Figure 52 for the reset pad configuration.

[3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see Figure 51).

[4] I^2C-bus pads compliant with the I^2C-bus specification for I^2C standard mode and I^2C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I2C lines. Open-drain configuration applies to all functions on this pin.

[5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled, and the pin is not 5 V tolerant (see Figure 51).

[6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

Table 10. LPC1100XL series: LPC1113/14/15 pin description table (LQFP48 and TFBGA48 package)

Symbol	LQFP48	TFBGA48	Start logic input	Type	Reset state [1]	Description
PIO0_0 to PIO0_11				I/O		**Port 0 —** Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block.
$\overline{\text{RESET}}$/PIO0_0	3[2]	C1[2]	yes	I	I; PU	**$\overline{\text{RESET}}$ —** External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The $\overline{\text{RESET}}$ pin can be left unconnected or be used as a GPIO pin if an external $\overline{\text{RESET}}$ function is not needed and Deep power-down mode is not used.
				I/O	-	**PIO0_0 —** General purpose digital input/output pin with 10 ns glitch filter.
PIO0_1/CLKOUT/ CT32B0_MAT2	4[3]	C2[3]	yes	I/O	I; PU	**PIO0_1 —** General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler.
				O	-	**CLKOUT —** Clockout pin.
				O	-	**CT32B0_MAT2 —** Match output 2 for 32-bit timer 0.
PIO0_2/SSEL0/ CT16B0_CAP0	10[3]	F1[3]	yes	I/O	I; PU	**PIO0_2 —** General purpose digital input/output pin.
				I/O	-	**SSEL0 —** Slave Select for SPI0.
				I	-	**CT16B0_CAP0 —** Capture input 0 for 16-bit timer 0.
PIO0_3	14[3]	H2[3]	yes	I/O	I; PU	**PIO0_3 —** General purpose digital input/output pin.
PIO0_4/SCL	15[4]	G3[4]	yes	I/O	I; IA	**PIO0_4 —** General purpose digital input/output pin (open-drain).
				I/O	-	**SCL —** I^2C-bus, open-drain clock input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_5/SDA	16[4]	H3[4]	yes	I/O	I; IA	**PIO0_5 —** General purpose digital input/output pin (open-drain).
				I/O	-	**SDA —** I^2C-bus, open-drain data input/output. High-current sink only if I^2C Fast-mode Plus is selected in the I/O configuration register.
PIO0_6/SCK0	22[3]	H6[3]	yes	I/O	I; PU	**PIO0_6 —** General purpose digital input/output pin.
				I/O	-	**SCK0 —** Serial clock for SPI0.
PIO0_7/$\overline{\text{CTS}}$	23[3]	G7[3]	yes	I/O	I; PU	**PIO0_7 —** General purpose digital input/output pin (high-current output driver).
				I	-	**$\overline{\text{CTS}}$ —** Clear To Send input for UART.

Table 10. LPC1100XL series: LPC1113/14/15 pin description table (LQFP48 and TFBGA48 package) *…continued*

Symbol	LQFP48	TFBGA48	Start logic input	Type	Reset state [1]	Description
PIO0_8/MISO0/ CT16B0_MAT0	27[3]	F8[3]	yes	I/O	I; PU	**PIO0_8 —** General purpose digital input/output pin.
				I/O	-	**MISO0 —** Master In Slave Out for SPI0.
				O	-	**CT16B0_MAT0 —** Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/ CT16B0_MAT1	28[3]	F7[3]	yes	I/O	I; PU	**PIO0_9 —** General purpose digital input/output pin.
				I/O	-	**MOSI0 —** Master Out Slave In for SPI0.
				O	-	**CT16B0_MAT1 —** Match output 1 for 16-bit timer 0.
SWCLK/PIO0_10/ SCK0/ CT16B0_MAT2	29[3]	E7[3]	yes	I	I; PU	**SWCLK —** Serial wire clock.
				I/O	-	**PIO0_10 —** General purpose digital input/output pin.
				I/O	-	**SCK0 —** Serial clock for SPI0.
				O	-	**CT16B0_MAT2 —** Match output 2 for 16-bit timer 0.
R/PIO0_11/ AD0/CT32B0_MAT3	32[5]	D8[5]	yes	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
				I/O	-	**PIO0_11 —** General purpose digital input/output pin.
				I	-	**AD0 —** A/D converter, input 0.
				O	-	**CT32B0_MAT3 —** Match output 3 for 32-bit timer 0.
PIO1_0 to PIO1_11				I/O		**Port 1 —** Port 1 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block.
R/PIO1_0/ AD1/CT32B1_CAP0	33[5]	C7[5]	yes	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
				I/O	-	**PIO1_0 —** General purpose digital input/output pin.
				I	-	**AD1 —** A/D converter, input 1.
				I	-	**CT32B1_CAP0 —** Capture input 0 for 32-bit timer 1.
R/PIO1_1/ AD2/CT32B1_MAT0	34[5]	C8[5]	no	O	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
				I/O	-	**PIO1_1 —** General purpose digital input/output pin.
				I	-	**AD2 —** A/D converter, input 2.
				O	-	**CT32B1_MAT0 —** Match output 0 for 32-bit timer 1.
R/PIO1_2/ AD3/CT32B1_MAT1	35[5]	B7[5]	no	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
				I/O	-	**PIO1_2 —** General purpose digital input/output pin.
				I	-	**AD3 —** A/D converter, input 3.
				O	-	**CT32B1_MAT1 —** Match output 1 for 32-bit timer 1.
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	39[5]	B6[5]	no	I/O	I; PU	**SWDIO —** Serial wire debug input/output.
				I/O	-	**PIO1_3 —** General purpose digital input/output pin.
				I	-	**AD4 —** A/D converter, input 4.
				O	-	**CT32B1_MAT2 —** Match output 2 for 32-bit timer 1.

Table 10. LPC1100XL series: LPC1113/14/15 pin description table (LQFP48 and TFBGA48 package) *…continued*

Symbol	LQFP48	TFBGA48	Start logic input	Type	Reset state [1]	Description
PIO3_2/$\overline{\text{DCD}}$/ CT16B0_MAT2/ SCK1	43[3]	A4[3]	no	I/O	I; PU	**PIO3_2 —** General purpose digital input/output pin.
				I	-	**$\overline{\text{DCD}}$ —** Data Carrier Detect input for UART.
				O	-	**CT16B0_MAT2 —** Match output 2 for 16-bit timer 0.
				I/O	-	**SCK1 —** Serial clock for SPI1.
PIO3_3/$\overline{\text{RI}}$/ CT16B0_CAP0	48[3]	A2[3]	no	I/O	I; PU	**PIO3_3 —** General purpose digital input/output pin.
				I	-	**$\overline{\text{RI}}$ —** Ring Indicator input for UART.
				I	-	**CT16B0_CAP0 —** Capture input 0 for 16-bit timer 0.
PIO3_4/ CT16B0_CAP1/RXD	18[3]	H4[3]	no	I/O	I; PU	**PIO3_4 —** General purpose digital input/output pin.
				I	-	**CT16B0_CAP1 —** Capture input 1 for 16-bit timer 0.
				I	-	**RXD —** Receiver input for UART
PIO3_5/ CT16B1_CAP1/TXD	21[3]	G6[3]	no	I/O	I; PU	**PIO3_5 —** General purpose digital input/output pin.
				I	-	**CT16B1_CAP1 —** Capture input 1 for 16-bit timer 1.
				O	-	**TXD —** Transmitter output for UART
V_{DD}	8; 44	E2; B4	-	I	-	3.3 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
XTALIN	6[6]	D1[6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	7[6]	E1[6]	-	O	-	Output from the oscillator amplifier.
V_{SS}	5; 41	D2; B5	-	I	-	Ground.

[1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to full V_{DD} level (V_{DD} = 3.3 V)); IA = inactive, no pull-up/down enabled.

[2] 5 V tolerant pad. $\overline{\text{RESET}}$ functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See Figure 52 for the reset pad configuration.

[3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see Figure 51).

[4] I^2C-bus pads compliant with the I^2C-bus specification for I^2C standard mode and I^2C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I2C lines. Open-drain configuration applies to all functions on this pin.

[5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled and the pin is not 5 V tolerant (see Figure 51).

[6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

10. Static characteristics

10.1 LPC1100, LPC1100L series

Table 16. Static characteristics (LPC1100, LPC1100L series)

T_{amb} = −40 °C to +85 °C, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
V_{DD}	supply voltage (core and external rail)		1.8	3.3	3.6	V
LPC1100 series (LPC111x/101/201/301) power consumption						
I_{DD}	supply current	Active mode; code `while(1){}` executed from flash				
		system clock = 12 MHz; V_{DD} = 3.3 V [2][3][4][5][6]	-	3	-	mA
		system clock = 50 MHz; V_{DD} = 3.3 V [2][3][5][6][7]	-	9	-	mA
		Sleep mode; system clock = 12 MHz; V_{DD} = 3.3 V [2][3][4][5][6]	-	2	-	mA
		Deep-sleep mode; V_{DD} = 3.3 V [2][3][8]	-	6	-	μA
		Deep power-down mode; V_{DD} = 3.3 V [2][9]	-	220	-	nA
LPC1100L series (LPC111x/002/102/202/302) power consumption in low-current mode[11]						
I_{DD}	supply current	Active mode; code `while(1){}` executed from flash				
		system clock = 1 MHz; V_{DD} = 3.3 V [2][3][5][6][10]	-	840	-	μA
		system clock = 6 MHz; V_{DD} = 3.3 V [2][3][5][6][10]	-	1	-	mA
		system clock = 12 MHz; V_{DD} = 3.3 V [2][3][4][5][6]	-	2	-	mA
		system clock = 50 MHz; V_{DD} = 3.3 V [2][3][5][6][7]	-	7	-	mA
		Sleep mode; system clock = 12 MHz; V_{DD} = 3.3 V [2][3][4][5][6]	-	1	-	mA
		system clock = 50 MHz; V_{DD} = 3.3 V [2][3][4][5][6]	-	5	-	mA
		Deep-sleep mode; V_{DD} = 3.3 V [2][3][8]	-	2	-	μA
		Deep power-down mode; V_{DD} = 3.3 V [2][9]	-	220	-	nA

10.3 ADC static characteristics

Table 18. ADC static characteristics

T_{amb} = −40 °C to +105 °C unless otherwise specified; ADC frequency 4.5 MHz, V_{DD} = 2.5 V to 3.6 V.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{IA}	analog input voltage		0	-	V_{DD}	V
C_{ia}	analog input capacitance		-	-	1	pF
E_D	differential linearity error	[1][2]	-	-	± 1	LSB
$E_{L(adj)}$	integral non-linearity	[3]	-	-	± 1.5	LSB
E_O	offset error	[4]	-	-	± 3.5	LSB
E_G	gain error	[5]	-	-	0.6	%
E_T	absolute error	[6]	-	-	± 4	LSB
R_{vsi}	voltage source interface resistance		-	-	40	kΩ
R_i	input resistance	[7][8]	-	-	2.5	MΩ

[1] The ADC is monotonic, there are no missing codes.

[2] The differential linearity error (E_D) is the difference between the actual step width and the ideal step width. See Figure 17.

[3] The integral non-linearity ($E_{L(adj)}$) is the peak difference between the center of the steps of the actual and the ideal transfer curve after appropriate adjustment of gain and offset errors. See Figure 17.

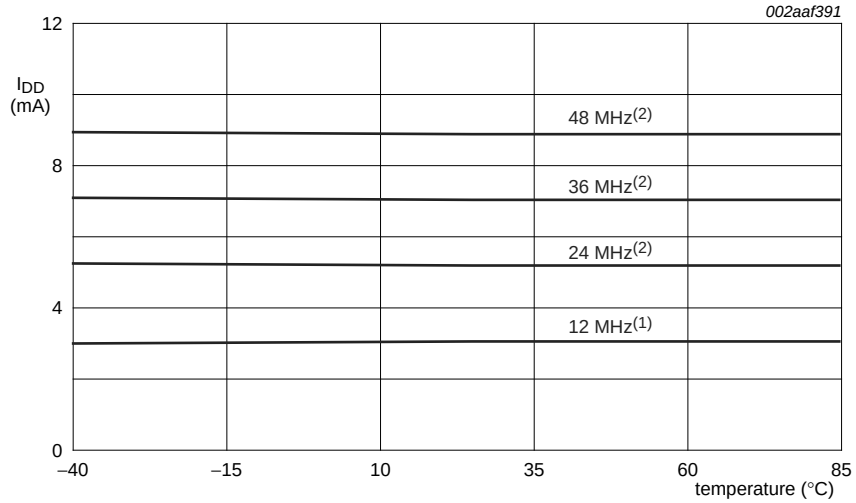
[4] The offset error (E_O) is the absolute difference between the straight line which fits the actual curve and the straight line which fits the ideal curve. See Figure 17.

[5] The gain error (E_G) is the relative difference in percent between the straight line fitting the actual transfer curve after removing offset error, and the straight line which fits the ideal transfer curve. See Figure 17.

[6] The absolute error (E_T) is the maximum difference between the center of the steps of the actual transfer curve of the non-calibrated ADC and the ideal transfer curve. See Figure 17.

[7] T_{amb} = 25 °C; maximum sampling frequency f_s = 400 kSamples/s and analog input capacitance C_{ia} = 1 pF.

[8] Input resistance R_i depends on the sampling frequency f_s: $R_i = 1 / (f_s \times C_{ia})$.

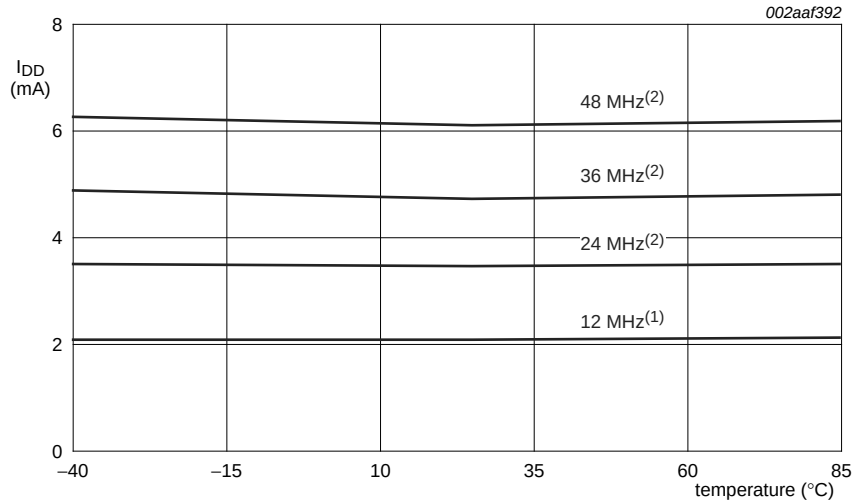


Conditions: V_{DD} = 3.3 V; active mode entered executing code `while(1){}` from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled.

(1) System oscillator and system PLL disabled; IRC enabled.

(2) System oscillator and system PLL enabled; IRC disabled.

Fig 19. Active mode: Typical supply current I_{DD} versus temperature for different system clock frequencies (for LPC111x/101/201/301)



Conditions: V_{DD} = 3.3 V; sleep mode entered from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled.

(1) System oscillator and system PLL disabled; IRC enabled.

(2) System oscillator and system PLL enabled; IRC disabled.

Fig 20. Sleep mode: Typical supply current I_{DD} versus temperature for different system clock frequencies (for LPC111x/101/201/301)

11. Dynamic characteristics

11.1 Power-up ramp conditions

Table 22. Power-up characteristics[1]

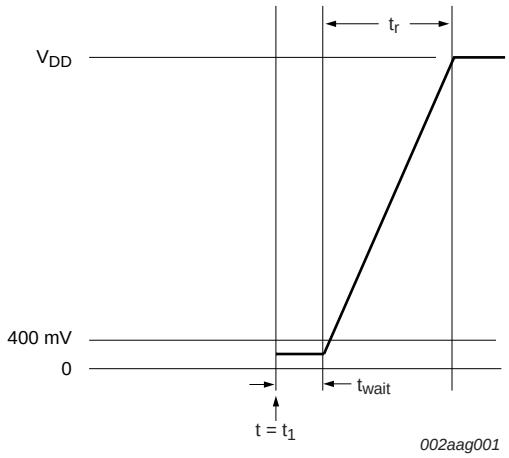
T_{amb} = −40 °C to +85 °C.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_r	rise time	at t = t_1: 0 < V_I ≤ 400 mV [2]	0	-	500	ms
t_{wait}	wait time	[2][3]	12	-	-	µs
V_I	input voltage	at t = t_1 on pin V_{DD}	0	-	400	mV

[1] Does not apply to the LPC1100XL series (LPC111x/103/203/303/323/333).

[2] See Figure 42.

[3] The wait time specifies the time the power supply must be at levels below 400 mV before ramping up.



Condition: 0 < V_I ≤ 400 mV at start of power-up (t = t_1)

Fig 42. Power-up ramp

11.2 Flash memory

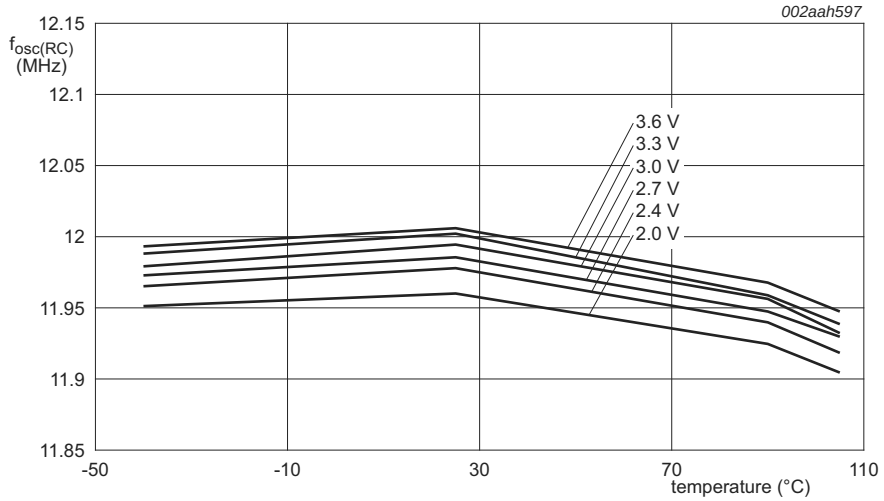
Table 23. Flash characteristics

T_{amb} = −40 °C to +105 °C, unless otherwise specified. T_{amb} = 85 °C for flash programming.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
N_{endu}	endurance	[1]	10000	100000	-	cycles
t_{ret}	retention time	powered	10	-	-	years
		unpowered	20	-	-	years
t_{er}	erase time	sector or multiple consecutive sectors	95	100	105	ms
t_{prog}	programming time	[2]	0.95	1	1.05	ms

[1] Number of program/erase cycles.

[2] Programming times are given for writing 256 bytes from RAM to the flash. Data must be written to the flash in blocks of 256 bytes. Flash programming operation temperature must not exceed T_{amb} = 85 °C.



Conditions: Frequency values are typical values. 12 MHz ± 1 % accuracy is guaranteed for 2.7 V ≤ V_{DD} ≤ 3.6 V and T_{amb} = −40 °C to +105 °C. Variations between parts may cause the IRC to fall outside the 12 MHz ± 1 % accuracy specification for voltages below 2.7 V.

Fig 45. Internal RC oscillator frequency versus temperature (J parts)

fundamental mode oscillation (the fundamental frequency is represented by L, C_L and R_S). Capacitance C_P in Figure 50 represents the parallel package capacitance and should not be larger than 7 pF. Parameters F_{OSC}, C_L, R_S and C_P are supplied by the crystal manufacturer (see Table 30).

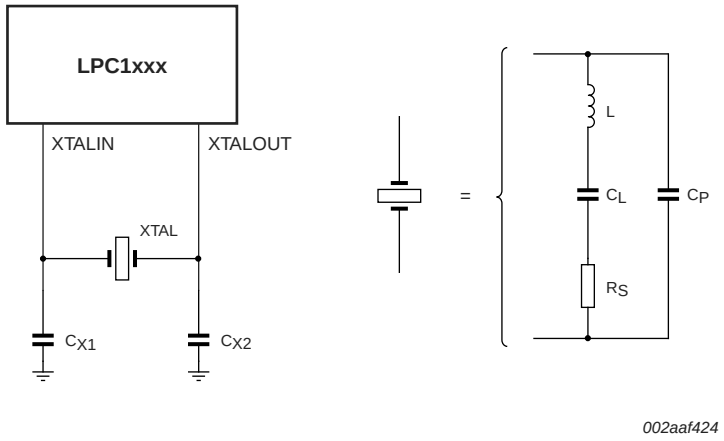


Fig 50. Oscillator modes and models: oscillation mode of operation and external crystal model used for C_{X1}/C_{X2} evaluation

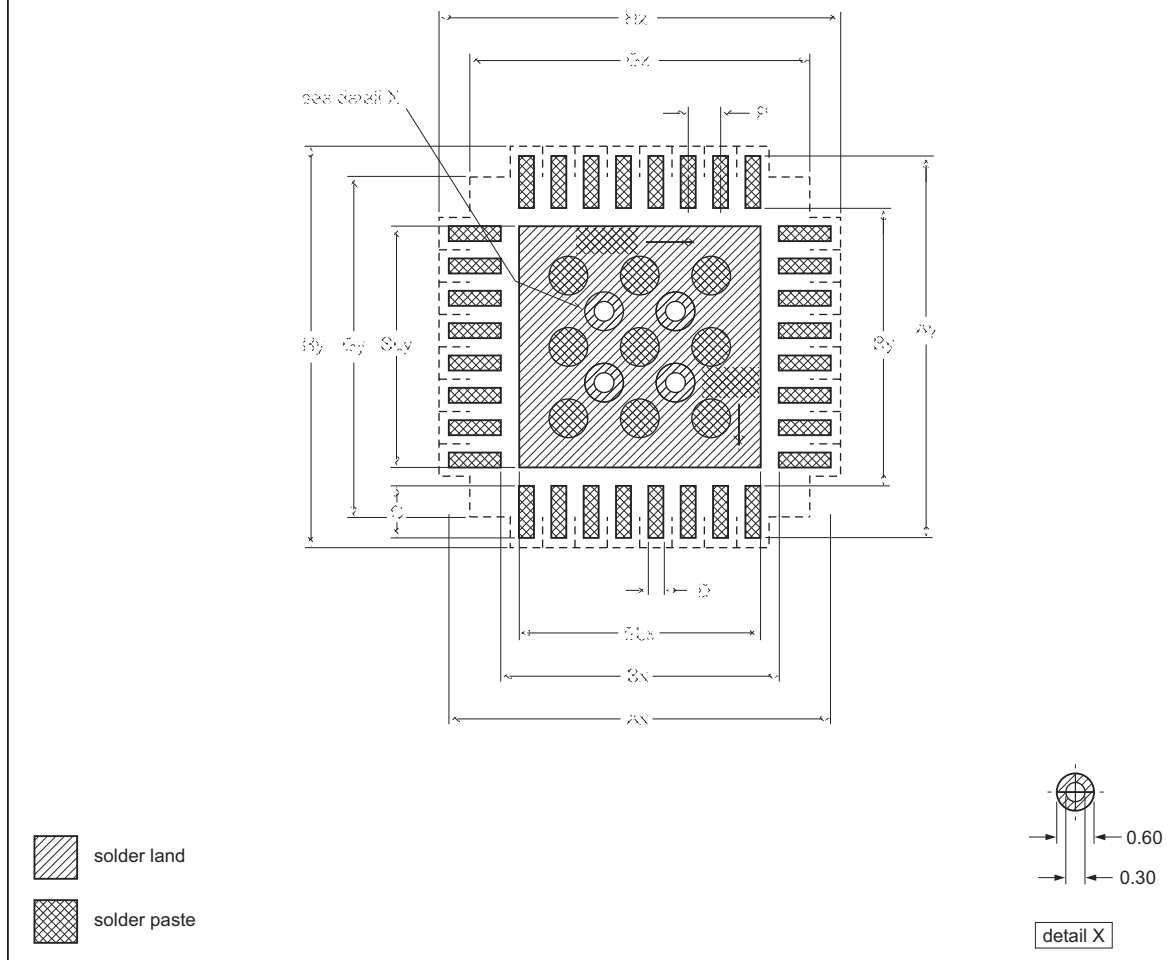
Table 30. Recommended values for C_{X1}/C_{X2} in oscillation mode (crystal and external components parameters) low frequency mode

Fundamental oscillation frequency F_{OSC}	Crystal load capacitance C_L	Maximum crystal series resistance R_S	External load capacitors C_{X1}, C_{X2}
1 MHz to 5 MHz	10 pF	< 300 Ω	18 pF, 18 pF
	20 pF	< 300 Ω	39 pF, 39 pF
	30 pF	< 300 Ω	57 pF, 57 pF
5 MHz to 10 MHz	10 pF	< 300 Ω	18 pF, 18 pF
	20 pF	< 200 Ω	39 pF, 39 pF
	30 pF	< 100 Ω	57 pF, 57 pF
10 MHz to 15 MHz	10 pF	< 160 Ω	18 pF, 18 pF
	20 pF	< 60 Ω	39 pF, 39 pF
15 MHz to 20 MHz	10 pF	< 80 Ω	18 pF, 18 pF

Table 31. Recommended values for C_{X1}/C_{X2} in oscillation mode (crystal and external components parameters) high frequency mode

Fundamental oscillation frequency F_{OSC}	Crystal load capacitance C_L	Maximum crystal series resistance R_S	External load capacitors C_{X1}, C_{X2}
15 MHz to 20 MHz	10 pF	< 180 Ω	18 pF, 18 pF
	20 pF	< 100 Ω	39 pF, 39 pF
20 MHz to 25 MHz	10 pF	< 160 Ω	18 pF, 18 pF
	20 pF	< 80 Ω	39 pF, 39 pF

Footprint information for reflow soldering of HVQFN33 package



Dimensions in mm

P	Ax	Ay	Bx	By	C	D	Gx	Gy	Hx	Hy	SLx	SLy	nSPx	nSPy
0.5	5.95	5.95	4.25	4.25	0.85	0.27	5.25	5.25	6.2	6.2	3.75	3.75	3	3

Issue date ~~11-11-15~~ 11-11-20

Fig 67. Reflow soldering of the HVQFN33 package (5x5)

Footprint information for reflow soldering of HVQFN33 package

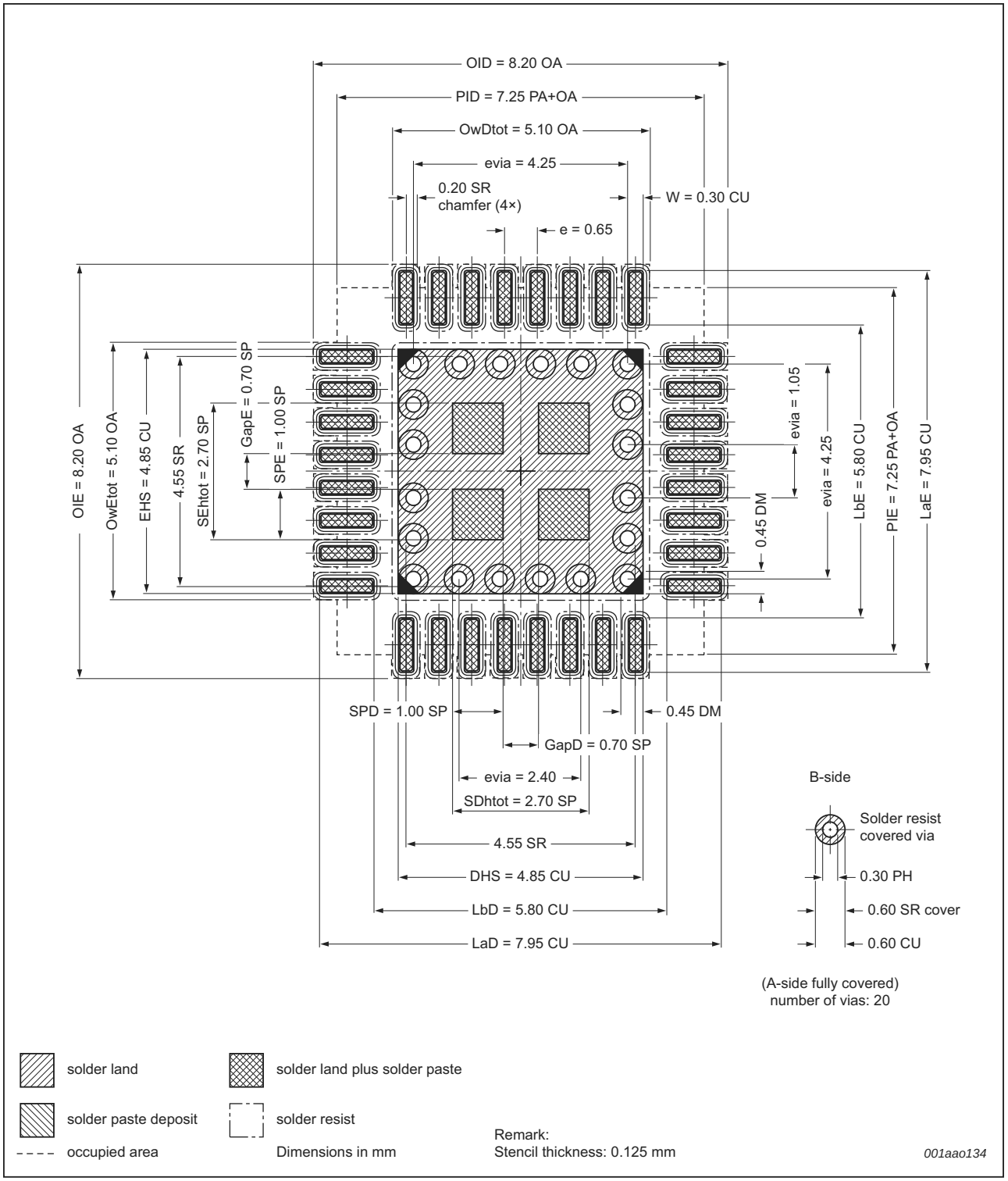
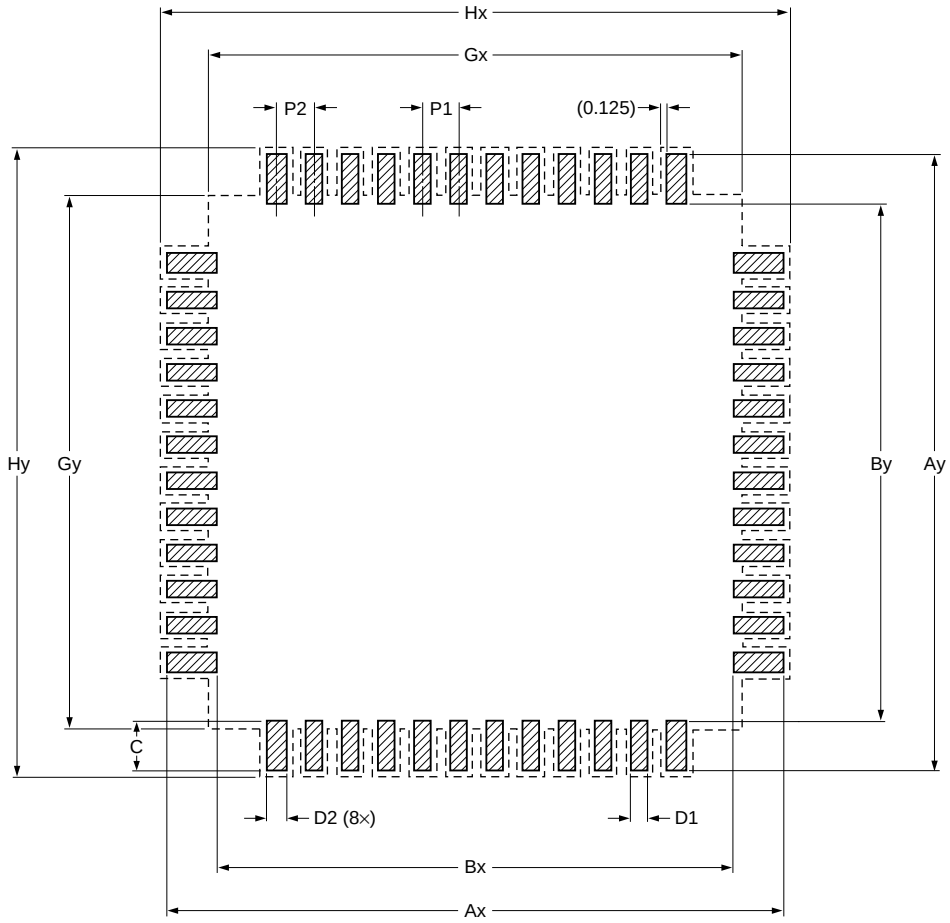


Fig 68. Reflow soldering of the HVQFN33 package (7x7)

Footprint information for reflow soldering of LQFP48 package **SOT313-2**



Generic footprint pattern

Refer to the package outline drawing for actual layout

solder land

occupied area

DIMENSIONS in mm

P1	P2	Ax	Ay	Bx	By	C	D1	D2	Gx	Gy	Hx	Hy
0.500	0.560	10.350	10.350	7.350	7.350	1.500	0.280	0.500	7.500	7.500	10.650	10.650

sot313-2_fr

Fig 69. Reflow soldering of the LQFP48 package

17. Revision history

Table 34. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
LPC111X v.9.2	20140326	Product data sheet	-	LPC111X v.9.1
Modifications:	• Pin description tables for RESET/PIO0_0 updated: In deep power-down mode, this pin must be pulled HIGH externally. The RESET pin can be left unconnected or be used as a GPIO pin if an external RESET function is not needed. See Section 6.2. • Pin description notes relating to open-drain I2C-bus pins updated for clarity in Section 6.2. • Pin description of the WAKEUP pin updated for clarity. See Section 6.2. • Parts added: LPC1114JHI33/303, LPC1111JHN33/103, LPC1112JHN33/203, LPC1113JHN33/203, LPC1114JHN33/303, LPC1114JBD48/333, LPC1112FHI33/102, LPC1114JBD48/303, LPC1114JBD48/323, LPC1113JBD48/303, LPC1113JHN33/303, LPC1112JHN33/103, LPC1111JHN33/203, LPC1114JHN33/203.			
LPC111X v.9.1	20131213	Product data sheet	-	LPC111X v.9
Modifications:	• Table 17 “Static characteristics (LPC1100XL series)”: – Added I_{DD} max spec for Deep-sleep and Deep power-down modes @ 25 °C and 105 °C. – Added Table note 11 “105 °C spec applies only to the LPC1112JHI33, LPC1114JHN33, LPC1115JBD48, and LPC1115JET48 parts.” – Updated Table note 12 “WAKEUP pin and RESET pin are pulled HIGH externally.” • Table 16 “Static characteristics (LPC1100, LPC1100L series)”: – Updated Table note 9 “WAKEUP pin and RESET pin are pulled HIGH externally.”			
LPC111X v.9	20131029	Product data sheet	-	LPC111X v.8.2
Modifications:	• Added LPC1112JHI33/203, LPC1114JHN33/333, LPC1115JBD48/303, and LPC1115JET48/303 parts. • Removed $t_{clk(H)}$ and $t_{clk(L)}$ from Figure 47 “SPI master timing in SPI mode” and Figure 48 “SPI slave timing in SPI mode”; spec not characterized. • Table 22 “Power-up characteristics[1]”: Added table note “Does not apply to LPC1100XL series”.			
LPC111X v.8.2	20130805	Product data sheet	-	LPC111X v.8.1
Modifications:	• Added LPC1115FET48/303.			
LPC111X v.8.1	20130524	Product data sheet	-	LPC111X v.8
Modifications:	• Table 4 thru Table 11: Added “5 V tolerant pad” to RESET/PIO0_0 table note. • Added Section 9 “Thermal characteristics”. • SRAM size corrected for part LPC1112FHN24/202 (4 kB). See Table 2.			
LPC111X v.8	20130220	Product data sheet	-	LPC111X v.7.5
Modifications:	• Table 16 “Static characteristics” added Pin capacitance section. • Default pin state corrected for pins PIO0_4 and PIO0_5 (I; IA) in Table 11 “LPC1100XL series: LPC1111/12/13/14 pin description table (HVQFN33 package)”. • Table 12 “Limiting values” expanded for clarity. • Table 19 “ Power consumption at very low frequencies using the watchdog oscillator” added. • Added Section 12.2 “Use of ADC input trigger signals”. • Added Section 12.8 “ADC effective input impedance”.			
LPC111X v.7.5	20121002	Product data sheet	-	LPC111X v.7.4